

KEMET Part Number: C0402C681J3GACTU
(C0402C681J3GAC7867)

SMD Comm COG, Ceramic, 680 pF, 5%, 25 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0402



Dimensions

| Chip Size | 0402 |
|-----------|-----------------|
| L | 1mm +/-0.05mm |
| W | 0.5mm +/-0.05mm |
| T | 0.5mm +/-0.05mm |
| S | 0.3mm MIN |
| B | 0.3mm +/-0.1mm |

Packaging Specifications

| | |
|----------------------------|------------------------|
| Packaging: | T&R, 180mm, Paper Tape |
| Packaging Quantity: | 10000 |

General Information

| | |
|--------------------------|--|
| Series: | SMD Comm COG |
| Style: | SMD Chip |
| Description: | SMD, MLCC, Ultra-Stable, Low Loss, Class I |
| Features: | Ultra-Stable, Low Loss, Class I |
| RoHS: | Yes |
| Termination: | Tin |
| Marking: | No |
| AEC-Q200: | No |
| Component Weight: | 1060 ug |
| Shelf Life: | 78 Weeks |
| MSL: | 1 |

Specifications

| | |
|--|---------------------------|
| Capacitance: | 680 pF |
| Measurement Condition: | 1 MHz 1.0Vrms |
| Capacitance Tolerance: | 5% |
| Voltage DC: | 25 VDC |
| Dielectric Withstanding Voltage: | 62.5 VDC |
| Temperature Range: | -55/+125°C |
| Temperature Coefficient: | COG |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC): | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor: | 0.1% 1 MHz 1.0Vrms |
| Aging Rate: | 0% Loss/Decade Hour |
| Insulation Resistance: | 100 GOhms |

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